

Vishay Siliconix

# N-Channel Reduced $Q_g$ , Fast Switching MOSFET

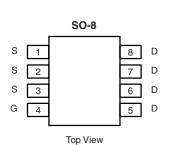
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	V <sub>DS</sub> (V) R <sub>DS(on)</sub> (Ω)			
12	0.0055 at $V_{GS}$ = 4.5 V	17		
	0.008 at V <sub>GS</sub> = 2.5 V	14		

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Available
- TrenchFET<sup>®</sup> Power MOSFETs
- PWM Optimized for High Efficiency
- Low Output Voltage
- 100 % R<sub>g</sub> Tested

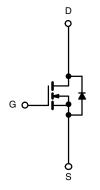
#### **APPLICATIONS**

- Synchronous Rectifier
- Point-of-Load Synchronous Buck Converter



Ordering Information: Si4866DY-T1-E3 (Lead Pb)-free)

Si4866DY-T1-GE3 (Lead Pb)-free and Halogen-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \degree C$ , unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	12		v	
Gate-Source Voltage		V <sub>GS</sub>	± 8			
	T <sub>A</sub> = 25 °C	1	17	11		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		14	8		
Pulsed Drain Current		I <sub>DM</sub>	± 50		A	
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	2.7	1.40		
	T <sub>A</sub> = 25 °C	PD	3.0 1.6		W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		2.0	1.0	vv	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 10 s	R <sub>thJA</sub>	34	41	
Maximum Junction-to-Ambient (MOSFET) <sup>a</sup>	Steady State	' 'thJA	67	80	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	15	19	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.



COMPLIANT

HALOGEN

Available

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<b>MOSFET SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions M		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$ 0.6				V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 9.6 V, V_{GS} = 0 V$ $V_{DS} = 9.6 V, V_{GS} = 0 V, T_{J} = 70 °C$			1	μA	
	IDSS				5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	40			А	
Drain-Source On-State Resistance <sup>a</sup>	Б	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 17		0.0045	0.0055	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 14$		0.0065	0.008		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 6 V, I_{D} = 17$		80		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{\rm S}$ = 2.7 A, $V_{\rm GS}$ = 0 V		0.70	1.1	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg			21	30		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 6 V$ , $V_{GS} = 4.5 V$ , $I_{D} = 17 A$		4.6		nC	
Gate-Drain Charge	Q <sub>gd</sub>			3.5			
Gate Resistance	R <sub>G</sub>		1.5	2.3	3.9	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			28	42		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 6 V, $R_L$ = 6 $\Omega$		32	48	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong \text{1}$ A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{G}$ = 6 $\Omega$		82	123	ns	
Fall Time	t <sub>f</sub>			35	53		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.7 A, dl/dt = 100 A/μs		60	90		

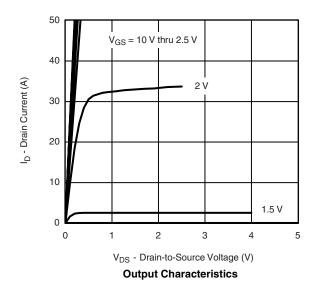
Notes:

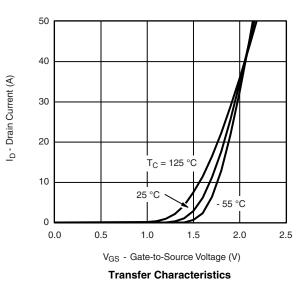
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





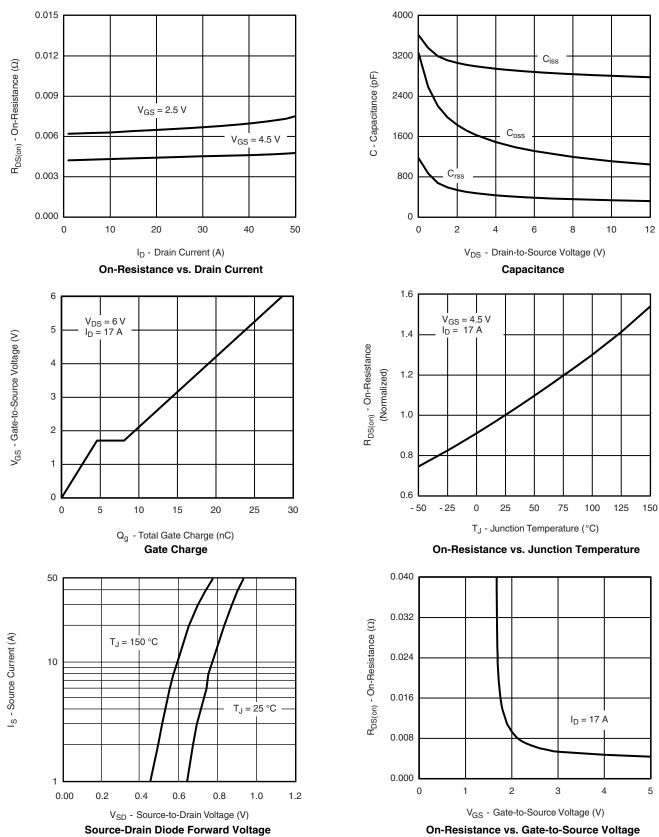
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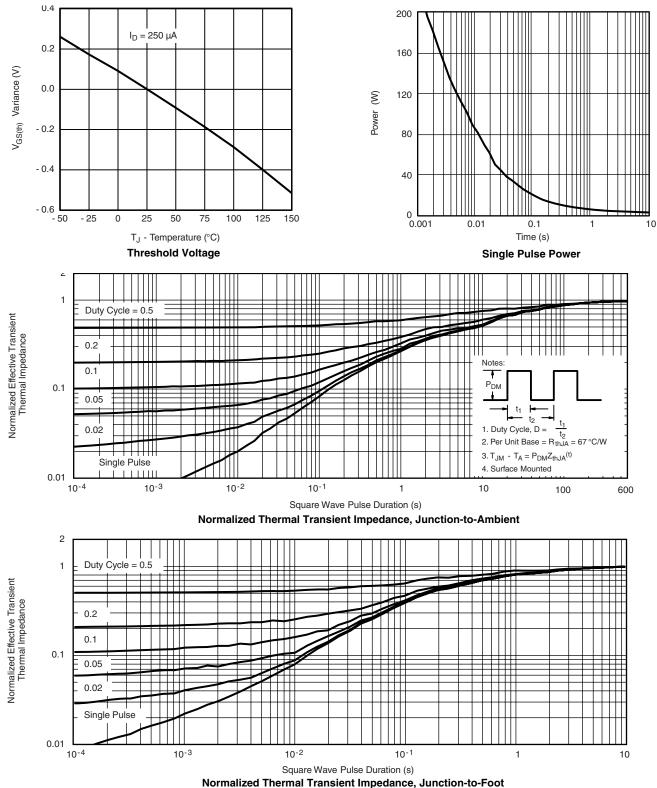
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## Si4866DY

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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?71699">www.vishay.com/ppg?71699</a>.

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# Package Information

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### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





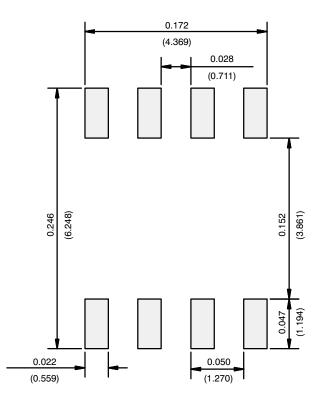
	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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